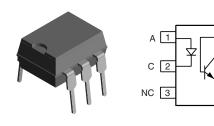


Vishay Semiconductors

Optocoupler, Photodarlington Output, High Gain, with Base Connection



FEATURES

- Isolation test voltage: 5300 V_{RMS}
- Coupling capacitance, 0.5 pF
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC





ROHS

DESCRIPTION

The H11B1, H11B2, H11B3 are industry standard optocouplers, consisting of a gallium arsenide infrared LED and a silicon photodarlington.

AGENCY APPROVALS

- UL1577, file no. E52744 system code J
- DIN EN 60747-5-5 (VDE 0884) available with option 1

| ORDER INFORMATION | |
|-------------------|-------------------------------|
| PART | REMARKS |
| H11B1 | CTR > 500 %, DIP-6 |
| H11B2 | CTR > 200 %, DIP-6 |
| H11B3 | CTR > 100 %, DIP-6 |
| H11B1-X007 | CTR > 500 %, SMD-6 (option 7) |
| H11B1-X009 | CTR > 500 %, SMD-6 (option 9) |
| H11B2-X009 | CTR > 200 %, SMD-6 (option 9) |

Note

For additional information on the available options refer to option information.

| ABSOLUTE MAXIMUM RATING | S | | | |
|-------------------------------------|----------------|-------------------|-------|-------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| INPUT | | | | |
| Reverse voltage | | V _R | 3 | V |
| Forward continuous current | | I _F | 60 | mA |
| Power dissipation | | P _{diss} | 100 | mW |
| Derate linearly from 25 °C | | | 1.33 | mW/°C |
| OUTPUT | | <u> </u> | | |
| Collector emitter breakdown voltage | | BV _{CEO} | 25 | V |
| Emitter collector breakdown voltage | | BV _{ECO} | 7 | V |
| Collector base breakdown voltage | | BV _{CBO} | 30 | V |
| Collector current (continuous) | | Ic | 100 | mA |
| Power dissipation | | P _{diss} | 150 | mW |
| Derate linearly from 25 °C | | | 2 | mW/°C |

H11B1, H11B2, H11B3

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| ABSOLUTE MAXIMUM RATINGS | | | | |
|---|--|------------------|--------------------|------------------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| COUPLER | | | | |
| Isolation test voltage between emitter and detector | | V _{ISO} | 5300 | V _{RMS} |
| Creepage distance | | | ≥ 7 | mm |
| Clearance distance | | | ≥ 7 | mm |
| Comparative tracking index per DIN IEC 112/VDE 0303, part 1 | | СТІ | 175 | |
| Isolation resistance | V _{IO} = 500 V, T _{amb} = 25 °C | R _{IO} | ≥ 10 ¹² | Ω |
| Isolation resistance | V _{IO} = 500 V, T _{amb} = 100 °C | R _{IO} | ≥ 10 ¹¹ | Ω |
| Total package dissipation (LED plus detector) | | P _{tot} | 260 | mW |
| Derate linearly from 25 °C | | | 3.5 | mW/°C |
| Storage temperature | | T _{stg} | - 55 to + 150 | °C |
| Operating temperature | | T _{amb} | - 55 to + 100 | °C |
| Lead soldering time at 260 °C | | | 10 | S |

Note

 T_{amb} = 25 °C, unless otherwise specified.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

| ELECTRICAL CHARACTERISTCS | | | | | | | | |
|--------------------------------------|---|-------|--------------------|------|------|------|------|--|
| PARAMETER | TEST CONDITION | PART | SYMBOL | MIN. | TYP. | MAX. | UNIT | |
| INPUT | INPUT | | | | | | | |
| | I 50 A | H11B1 | V _F | | 1.1 | 1.5 | V | |
| Forward voltage | I _F = 50 mA | H11B2 | V_{F} | | 1.1 | 1.5 | V | |
| | I _F = 10 mA | H11B3 | V_{F} | | 1.1 | 1.5 | V | |
| Reverse current | V _R = 3 V | | I _R | | | 10 | μΑ | |
| Junction capacitance | $V_F = 0 V, f = 1 MHz$ | | C _j | | 50 | | pF | |
| OUTPUT | | | | | | | | |
| Collector emitter breakdown voltage | $I_C = 1 \text{ mA}, I_F = 0 \text{ mA}$ | | BV _{CEO} | 30 | | | V | |
| Emitter collector breakdown voltage | $I_E = 100 \mu A, I_F = 0 \text{ mA}$ | | BV _{ECO} | 7 | | | V | |
| Collector base breakdown voltage | $I_C = 100 \mu\text{A}$, $I_F = 0 \text{mA}$ | | BV _{CBO} | 30 | | | V | |
| Collector emitter leakage current | $V_{CE} = 10 \text{ V}, I_F = 0 \text{ mA}$ | | I _{CEO} | | | 100 | nA | |
| COUPLER | | | | | | | | |
| Saturation voltage collector-emitter | $I_C = 1 \text{ mA}, I_C = 1 \text{ mA}$ | | V _{CEsat} | | | 1 | V | |
| Capacitance (input to output) | | | C _{IO} | | 0.5 | | pF | |

Note

T_{amb} = 25 °C, unless otherwise specified.

Minimum and maximum values were tested requierements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

| CURRENT TRANSFER RATIO | | | | | | | |
|---------------------------|--|-------|-------------------|------|------|------|------|
| PARAMETER | TEST CONDITION | PART | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| DC current transfer ratio | V _{CE} = 5 V, I _F = 1 mA | H11B1 | CTR _{DC} | 500 | | | % |
| | | H11B2 | CTR _{DC} | 200 | | | % |
| | | H11B3 | CTR _{DC} | 100 | | | % |



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| SWITCHING CHARACTERISTICS | | | | | | | |
|---------------------------|---|------------------|------|------|------|------|--|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT | |
| Switching times | I_F = 5 mA, V_{CE} = 10 V, R_L = 100 Ω | t _{on} | | 5 | | μs | |
| | | t _{off} | | 30 | | μs | |

TYPICAL CHARACTERISTICS

T_{amb} = 25 °C, unless otherwise specified

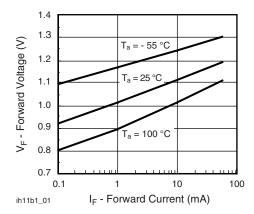


Fig. 1 - Forward Voltage vs. Forward Current

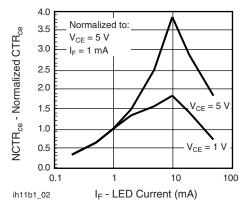


Fig. 2 - Normalized Non-Saturated and Saturated CTR $_{\rm CE}$ vs. LED Current

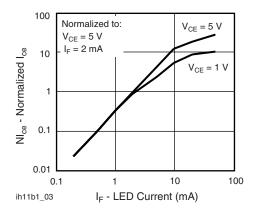


Fig. 3 - Normalized Non-Saturated and Saturated I_{CE} vs. LED Current

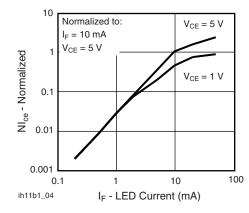


Fig. 4 - Normalized Non-Saturated and Saturated Collector Emitter Current vs. LED Current

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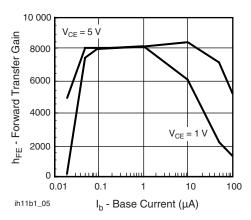
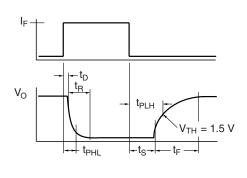


Fig. 5 - Non-Saturated and Saturated h_{FE} vs. Base Current



ih11b1_08

Fig. 8 - Switching Waveform

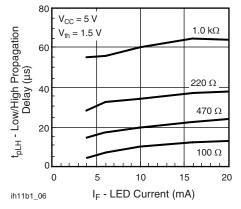


Fig. 6 - Low to High Propagation Delay vs. Collector Load Resistance and LED Current

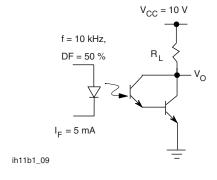


Fig. 9 - Switching Schematic

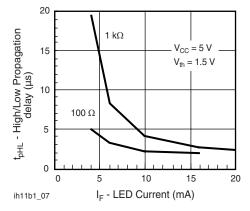


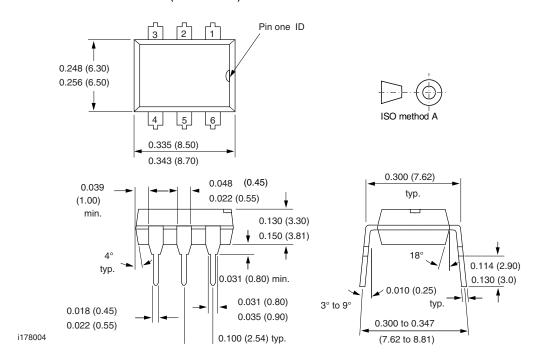
Fig. 7 - High to Low Propagation Delay vs. Collector Load Resistance and LED Current

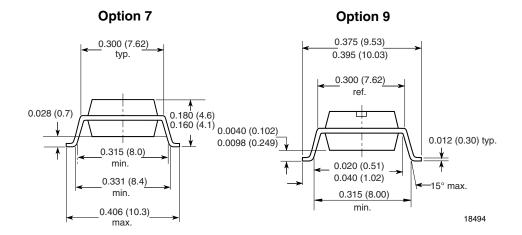
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PACKAGE DIMENSIONS in inches (millimeters)





H11B1, H11B2, H11B3

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OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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